ABBOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan-	C, Bannockł	ourn, Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a decla the declaratio	ration of the n encompa	e substances sses all lowe	within the r r level mate	nanufacture rials for whi	r listed ite ich the ma	m. Note: if nufacturer	the item is an as has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg					, Informati	on			
Supplier Information															
Company name*	Company unique ID			Unique ID Authority					Response Date*						
onsemi												2025-07-07			
Contact Name	Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
Authorized Representative*	Title - Representative			Phone - Representative*				Email - Representative*							
Product-Env-Stewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com					
Requester Item Number	Mfr Item	n Number	Mfr Item Name NSEB THAI TRANS			Effective D	Date Version Manufacturing Site		ng Site	W	eight*	UOM	Unit Type		
	NB6N11	SMNG				2025-07-07 MY1			23.69		mg	Each			
Manufacturing Proccess Informat	ion		1				1				1		1	I	
Terminal Plating / Grid Array Mat	erial 7	Terminal Base	Alloy	J-STD-020 MS	L Rating	Peak Process Body Temper		y Temperatu	ture Max Time at Peak Tem		Temperatu	ture Number of Reflow Cycles		les	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30		second	seconds 3			
Comments												•			
evel 1 - maximum time at peak temperatu	e during so	ldering is 10-3	0 seconds												
for more information regarding material o	omposition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.25	mg	Supplier	Silicon (Si)	7440-21-3		0.25	mg
Die Attach	0.65	mg	Supplier	Silver (Ag)	7440-22-4		0.4875	mg
			Supplier	Epoxy resins	129915-35-1		0.1625	mg
Lead Frame	10.08	mg	Supplier	Tin (Sn)	7440-31-5		0.0252	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0222	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0252	mg
			Supplier	Copper (Cu)	7440-50-8		10.0074	mg
Mold Compound-Black	12.09	mg		Epoxy resin	proprietary data		0.5682	mg
			Supplier	Phenol Resin	Proprietary Data		0.5682	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0121	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.9415	mg
Plating	0.48	mg	Supplier	Palladium (Pd)	7440-05-3		0.0115	mg
			В	Nickel (Ni)	7440-02-0		0.4224	mg
			Supplier	Gold (Au)	7440-57-5		0.0461	mg
Wire Bond - Au	0.14	mg	Supplier	Gold (Au)	7440-57-5		0.14	mg